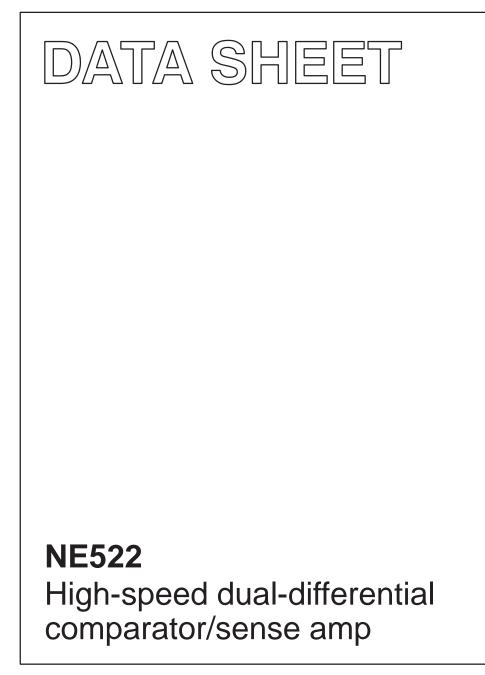
INTEGRATED CIRCUITS



Product data Supersedes data of 1994 Aug 31 File under Integrated Circuits, IC11 Handbook 2001 Aug 03





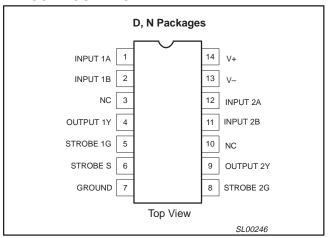
FEATURES

- 15 ns maximum guaranteed propagation delay
- 20 μ A maximum input bias current
- TTL-compatible strobes and outputs
- Large common-mode input voltage range
- Operates from standard supply voltages

APPLICATIONS

- MOS memory sense amp
- A-to-D conversion
- High-speed line receiver

PIN CONFIGURATION





BLOCK DIAGRAM

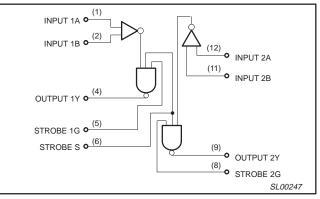


Figure 2. Block Diagram

ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
14-Pin Plastic DIP	0 °C to +70 °C	NE522N	SOT27-1
14-Pin Plastic SO	0 °C to +70 °C	NE522D	SOT108-1

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNITS
	Single supply voltage		
V+	Positive	+7	V
V-	Negative	-7	V
V _{IDR}	Differential input voltage	±6	V
V _{IN}	Input voltage		
	Common-mode	±5	V
	Strobe/gate	+5.25	V
PD	Power dissipation	600	mW
T _{amb}	Operating temperature range	0 to 70	°C
T _{stg}	Storage temperature range	-65 to +150	°C
T _{sld}	Lead soldering temperature (10 sec max)	+230	°C

EQUIVALENT SCHEMATIC

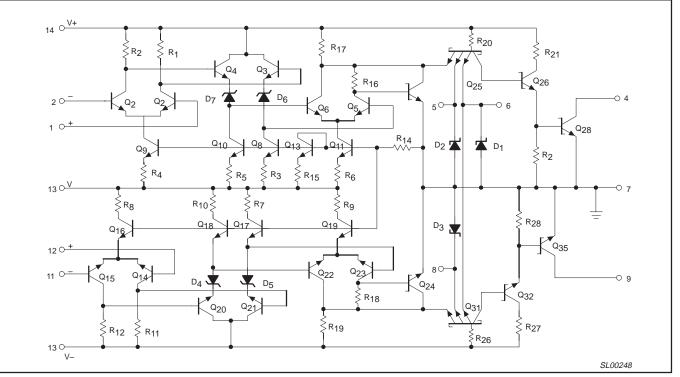


Figure 3. Equivalent Schematic

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High-speed dual-differential comparator/sense amp

DC ELECTRICAL CHARACTERISTICS

V± = ±5 V ±5%; T_{amb} = 0 °C to +70 °C, unless otherwise stated.

SYMBOL	DADAMETED	TEST CONDITIONS		LIMITS		
STMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
V _{OS}	Input offset voltage At 25 °C Over temperature range	V+ = +4.75 V; V- = -4.75 V		6	7.5 10	mV mV
I _{BIAS}	Input bias current At 25 °C Over temperature range	V+ = +5.25 V; V- = -5.25 V		7.5	20 40	μΑ μΑ
I _{OS}	Input offset current At 25 °C Over temperature range	V+ = +5.25 V; V- = -5.25 V		1.0	5 12	μΑ μΑ
V _{CM}	Common-mode voltage range	V+ = +4.75 V; V- = -4.75 V	-3		+3	V
V _{IL}	LOW-level input voltage At 25 °C Over temperature range				0.8 0.7	V V
V _{IH}	High level temperature		2.0			V
liH	HIGH-level input current 1G or 2G strobe Common strobe S	V+ = +5.25 V; V- = -5.25 V; V _{IH} = 2.7 V			50 100	μA μA
IIL	LOW-level input current 1G or 2G strobe Common strobe S	V _{IL} = 0.5 V			-2.0 -4.0	mA mA
V _{OL}	LOW-level output voltage	V+ = +5.25 V; V- = -5.25 V; V _{I(S)} = 2.0 V; I_{LOAD} = 20 mA			0.5	V
I _{ОН}	HIGH-level output current	V+ = +4.75 V; V- = -4.75 V; V _{OH} = 5.25 V			250	μΑ
V+ V-	Supply voltage Positive Negative		4.75 4.75	5.0 5.0	5.25 5.25	V V
I _{CC+}	Supply current Positive Negative	V+ = +5.25 V; V- = -5.25 V; T_{amb} = 25 °C		27 -15	35 –28	mA

AC ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C; R_L = 280 $\Omega;$ C_L = 15 pF; unless otherwise stated.

SYMBOL	PARAMETER			LIMITS			
STWBUL	PARAMETER	FROM INPUT	ΤΟ ΟυΤΡυΤ	MIN	TYP	MAX	UNITS
I _R	Input resistance				4		kΩ
Ι _C	Input capacitance				3		pF
Large-sigr	al switching speed						
	Propagation delay						
t _{PLH(D)}	Low to high ¹	Amp	Output		10	15	
t _{PHL(D)}	High to low ¹	Amp	Output		8	12	ns
t _{PLH(S)}	Low to high ²	Strobe	Output		6	13	
t _{PHL(S)}	High to low ²	Strobe	Output		5	9	
I _{MAX}	Maximum operating frequency			25	35		MHz

NOTES:

1. Response time measured from 0 V point of +100 mV_{P-P} 10 MHz square wave to the 1.5 V point of the output. 2. Response time measured from 1.5 V point of the input to 1.5 V point of the output.

LOGIC FUNCTION TABLE

V _{ID} (A+, B ⁻)	STRS	STRG	OUTPUT TRANSISTOR
<-V _{OS}	Н	Н	ON
$< -V_{OS}$ $-V_{OS} < V_{ID} < V_{OS}$	Н	н	Undefined
> V _{OS}	Н	Н	OFF
Х	L	Х	OFF
Х	Х	L	OFF

TYPICAL PERFORMANCE CHARACTERISTICS

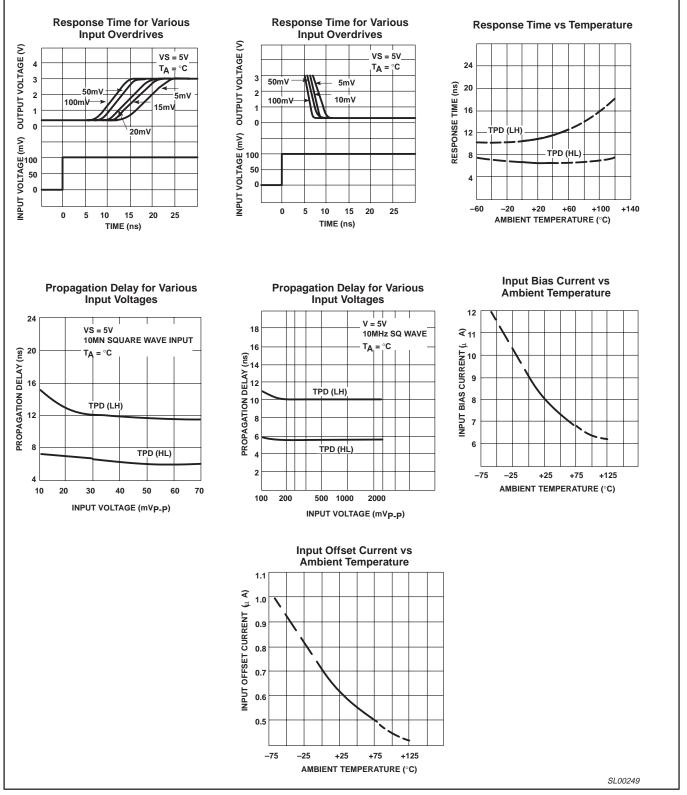


Figure 4. Typical Performance Characteristics

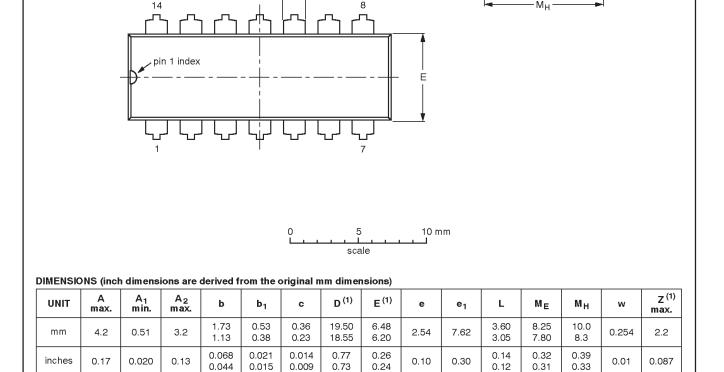
2001 Aug 03

seating plane

High-speed dual-differential comparator/sense amp

D

DIP14: plastic dual in-line package; 14 leads (300 mil)



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES		EUROPEAN			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001	SC-501-14			-95-03-11 99-12-27

NE522

SOT27-1

ME

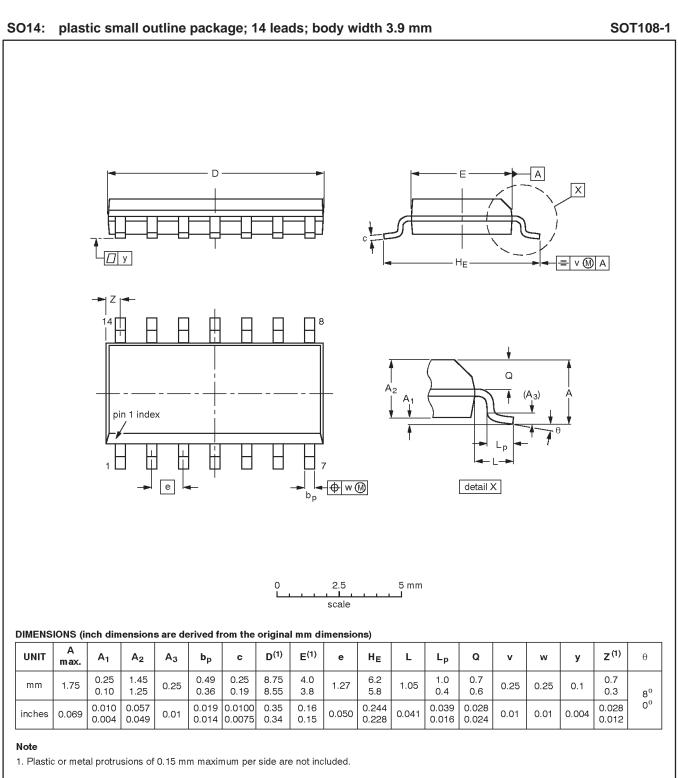
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NOTES

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Data sheet status ^[1]	Product status ^[2]	Definitions
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